

## **MOSFET**

## OptiMOS<sup>™</sup>3 Power-Transistor, 60 V

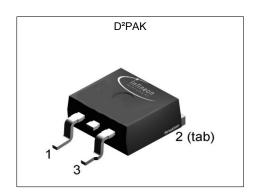
### **Features**

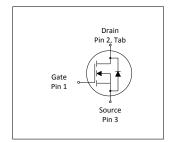
- for sync. rectification, drives and dc/dc SMPS
- Excellent gate charge x R<sub>DS(on)</sub> product (FOM)
  Very low on-resistance R<sub>DS(on)</sub>
  N-channel, normal level

- Avalanche rated
- Qualified according to JEDEC<sup>1)</sup> for target applications
  Pb-free plating; RoHS compliant
  Halogen-free according to IEC61249-2-21



Takoro T Troj T Orrormanoo T aramiotoro							
Parameter	Value	Unit					
$V_{ extsf{DS}}$	60	V					
R <sub>DS(on),max</sub>	3.7	mΩ					
I <sub>D</sub>	132	A					











Type / Ordering Code	Package	Marking	Related Links
IPB037N06N3 G	PG-TO 263-3	037N06N	-

# OptiMOS<sup>™</sup>3 Power-Transistor, 60 V



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## OptiMOS<sup>™</sup>3 Power-Transistor, 60 V IPB037N06N3 G



1 Maximum ratings at  $T_A$ =25 °C, unless otherwise specified

Table 2 Maximum ratings

Danamatan	Cumbal		Values			Note / Took Operalities	
Parameter	Symbol	Min.	Min. Typ.		Unit	Note / Test Condition	
Continuous drain current	I <sub>D</sub>	-	-	132 101	А	T <sub>C</sub> =25 °C T <sub>C</sub> =100 °C	
Pulsed drain current <sup>1)</sup>	I <sub>D,pulse</sub>	-	-	528	Α	<i>T</i> <sub>C</sub> =25 °C	
Avalanche energy, single pulse	E <sub>AS</sub>	-	-	165	mJ	$I_{\rm D}$ =90 A, $R_{\rm GS}$ =25 $\Omega$	
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-	
Power dissipation	P <sub>tot</sub>	-	-	188	W	<i>T</i> <sub>C</sub> =25 °C	
Operating and storage temperature	$T_{\rm j},~T_{\rm stg}$	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56	

#### Thermal characteristics 2

Thermal characteristics Table 3

Develope	Cumbal	Values			1124	Nata (Tant Canalities	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	8.0	K/W	-	
Thermal resistance, junction - ambient, minimal footprint	R <sub>thJA</sub>	-	-	62	K/W	-	
Thermal resistance, junction - ambient, 6 cm² cooling area²)	R <sub>thJA</sub>	-	-	40	K/W	-	

#### **Electrical characteristics** 3

Table 4 **Static characteristics** 

Paramatan.	0		Values			Note / Test Condition	
Parameter	Symbol	Min. Typ		Тур. Мах.			
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	60	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	2	3	4	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=90\ \mu {\rm A}$	
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μΑ	V <sub>DS</sub> =60 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =60 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C	
Gate-source leakage current	$I_{\mathrm{GSS}}$	-	1	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	3.0	3.7	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =90 A	
Gate resistance	R <sub>G</sub>	-	1.3	-	Ω	-	
Transconductance	<b>g</b> fs	61	121	-	S	$ V_{DS}  > 2 I_D R_{DS(on)max}, I_D = 90 A$	

 $<sup>^{1)}</sup>$  See Diagram 3  $^{2)}$  Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70  $\mu m$  thick) copper area for drain connection. PCB is vertical in still air.

## OptiMOS<sup>™</sup>3 Power-Transistor, 60 V IPB037N06N3 G



 Table 5
 Dynamic characteristics

Downworks:	Cymphal	Values			11	Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance	C <sub>iss</sub>	-	8000	11000	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz	
Output capacitance	Coss	-	1700	2300	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz	
Reverse transfer capacitance	Crss	-	58	87	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =30 V, f=1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	_	30	-	ns	$V_{DD}$ =30 V, $V_{GS}$ =10 V, $I_{D}$ =90 A, $R_{G,ext}$ =3.5 $\Omega$	
Rise time	t <sub>r</sub>	-	70	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =90 A, $R_{\rm G,ext}$ =3.5 $\Omega$	
Turn-off delay time	$t_{\sf d(off)}$	_	40	-	ns	$V_{DD}$ =30 V, $V_{GS}$ =10 V, $I_{D}$ =90 A, $R_{G,ext}$ =3.5 $\Omega$	
Fall time	t <sub>f</sub>	_	5	_	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =90 A, $R_{\rm G,ext}$ =3.5 $\Omega$	

Table 6 Gate charge characteristics<sup>1)</sup>

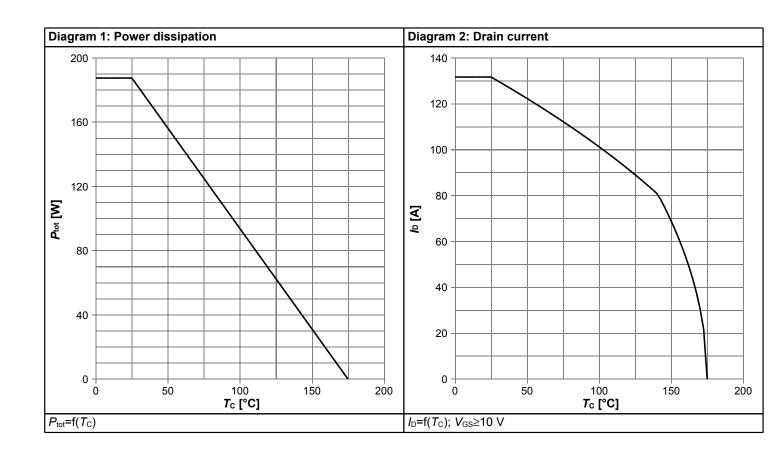
Devementar	Cross bod	Values			11	Nata / Tank Canadikian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Gate to source charge	Q <sub>gs</sub>	-	42	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =90 A, $V_{\rm GS}$ =0 to 10 V	
Gate to drain charge	$Q_{\rm gd}$	-	9	-	nC	V <sub>DD</sub> =30 V, I <sub>D</sub> =90 A, V <sub>GS</sub> =0 to 10 V	
Switching charge	Q <sub>sw</sub>	-	27	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =90 A, $V_{\rm GS}$ =0 to 10 V	
Gate charge total	Qg	-	98	-	nC	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =90 A, $V_{\rm GS}$ =0 to 10 V	
Gate plateau voltage	V <sub>plateau</sub>	-	5.3	-	V	$V_{\rm DD}$ =30 V, $I_{\rm D}$ =90 A, $V_{\rm GS}$ =0 to 10 V	
Output charge	Qoss	-	79	-	nC	V <sub>DD</sub> =30 V, V <sub>GS</sub> =0 V	

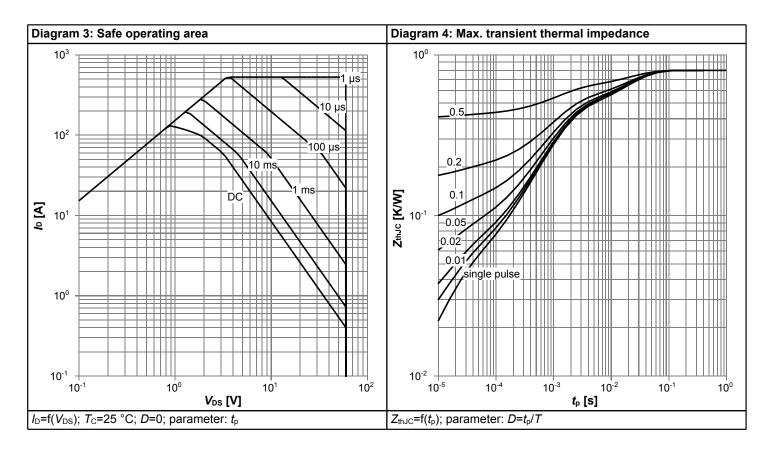
## Table 7 Reverse diode

Doromotor	Symbol		Values			Note / Took Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continous forward current	Is	-	-	117	Α	<i>T</i> <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	528	Α	<i>T</i> <sub>C</sub> =25 °C	
Diode forward voltage	<b>V</b> <sub>SD</sub>	-	0.97	1.2	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =90 A, T <sub>j</sub> =25 °C	
Reverse recovery time	<i>t</i> <sub>rr</sub>	-	125	-	ns	V <sub>R</sub> =30 V, I <sub>F</sub> =50A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	
Reverse recovery charge	Qrr	-	110	-	nC	V <sub>R</sub> =30 V, I <sub>F</sub> =50A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	

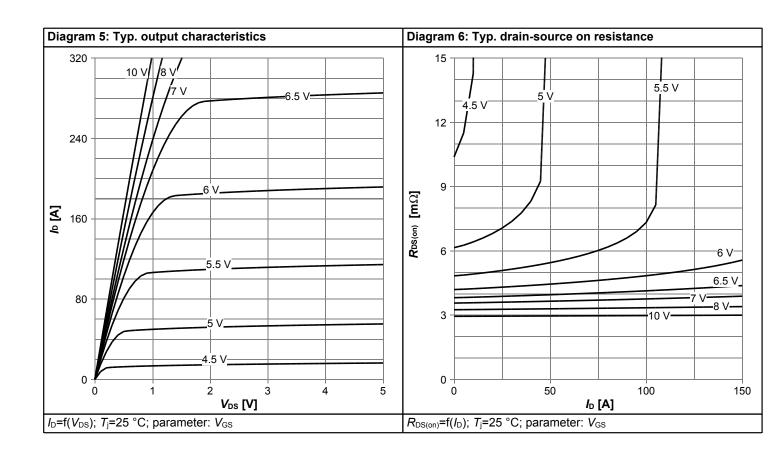


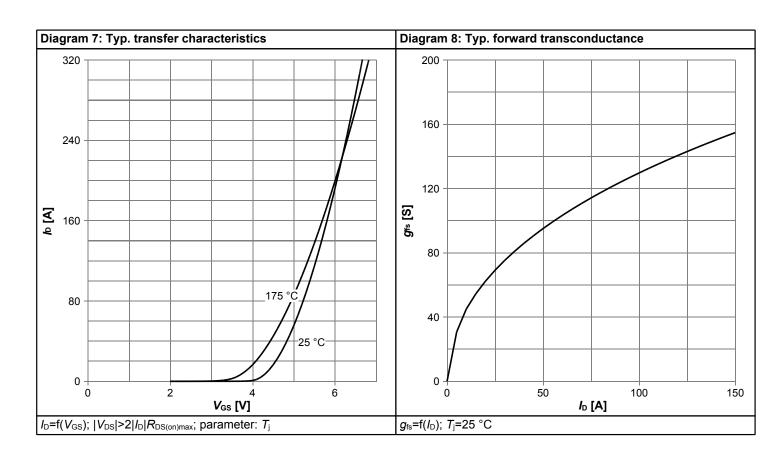
## 4 Electrical characteristics diagrams



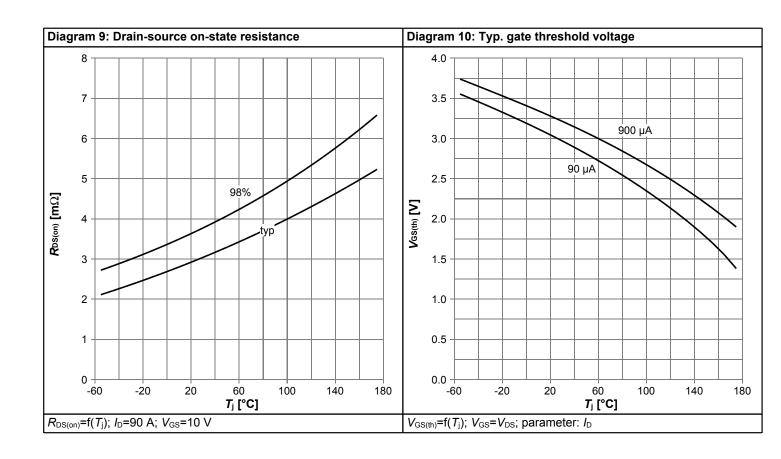


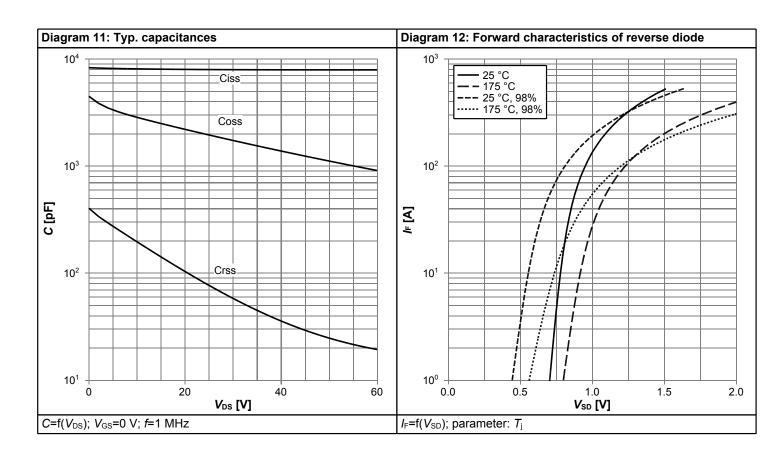




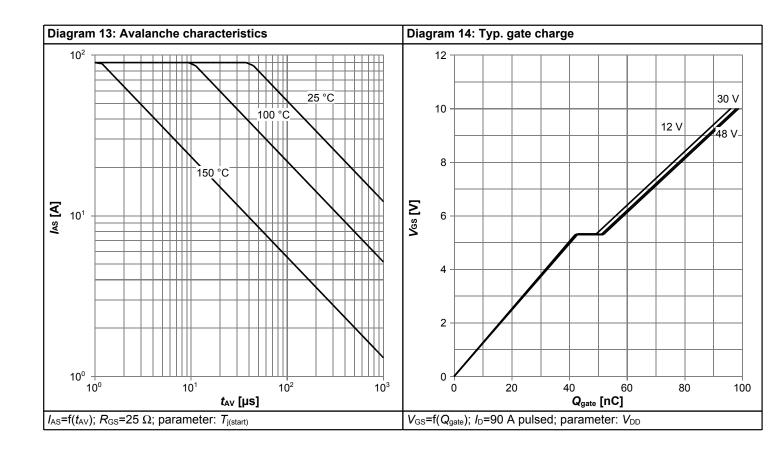


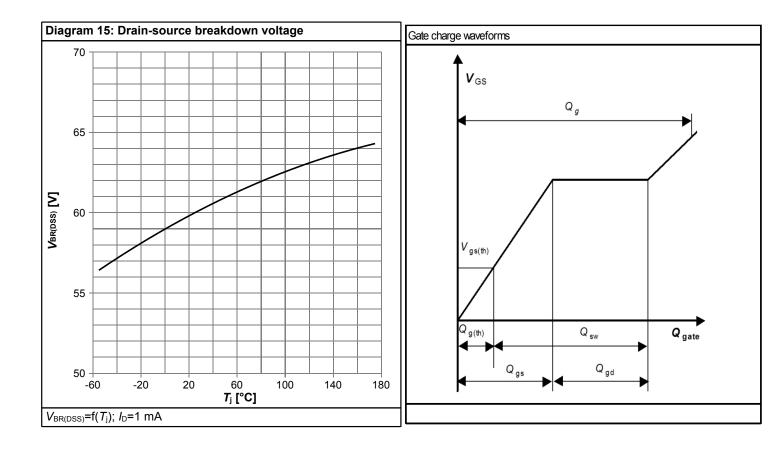






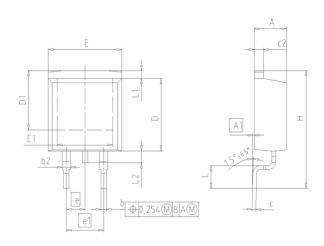


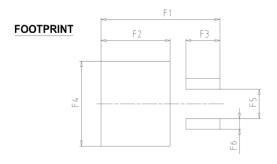






## 5 Package Outlines





DIM	MILLIN	METERS	INCI	HES		
DIM	MIN	MAX	MIN	MAX		
Α	4.30	4.57	0.169	0.180		
A1	0.00	0.25	0.000	0.010		
b	0.65	0.85	0.026	0.033		
b2	0.95	1.15	0.037	0.045		
С	0.33	0.65	0.013	0.026		
c2	1.17	1.40	0.046	0.055		
D	8.51	9.45	0.335	0.372		
D1	7.10	7.90	0.280	0.311		
E	9.80	10.31	0.386	0.406		
E1	6.50	8.60	0.256	0.339		
е	2.	54	0.100			
e1	5.	08	0.200			
N		2	2			
Н	14.61	15.88	0.575	0.625		
L	2.29	3.00	0.090	0.118		
L1	0.70	1.60	0.028	0.063		
L2	1.00	1.78	0.039	0.070		
F1	16.05	16.25	0.632	0.640		
F2	9.30	9.50	0.366	0.374		
F3	4.50	4.70	0.177	0.185		
F4	10.70	10.90	0.421	0.429		
F5	3.65	3.85	0.144	0.152		
F6	1.25	1.45	0.049	0.057		

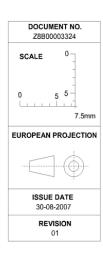


Figure 1 Outline PG-TO 263-3, dimensions in mm/inches

## OptiMOS<sup>™</sup>3 Power-Transistor, 60 V





## **Revision History**

IPB037N06N3 G

Revision: 2017-08-08, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2017-08-08	Update product current

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